1. General description

Planar Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Extremely low leakage current I_R = 235 nA
- Average forward current: I_{F(AV)} ≤ 2 A
- Reverse voltage: V_R ≤ 60 V
- Low forward voltage V_F = 600 mV
- High power capability due to clip-bonding technology
- High temperature T_i ≤ 175 °C
- Small and flat lead SMD plastic package
- · Suitable for both reflow and wave soldering
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- · Low voltage rectification
- · High efficiency DC-to-DC conversion
- · Switch mode power supply
- Reverse polarity protection
- · Low power consumption applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{sp} \leq 165 °C	-	-	2	А
V_R	reverse voltage	T _j = 25 °C	-	-	60	V
V _F	forward voltage	I_F = 2 A; $t_p \le 300 \text{ μs}$; $\delta \le 0.02$; T_j = 25 °C	-	600	670	mV
I _R	reverse current	$V_R = 60 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}$	-	235	700	nA



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		к .[К. а
2	А	anode	1 2 CFP5 (SOD128)	sym001

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number			
	Name	Description	Version
PMEG6020AELP-Q		plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG6020AELP-Q	DL

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	60	V
I _F	forward current	δ = 1; T _{sp} = 160 °C		-	2.83	А
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; $T_{amb} \le$ 110 °C	[1]	-	2	A
		δ = 0.5; f = 20 kHz; square wave; T _{sp} ≤ 165 °C		-	2	A
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; half-sine wave; $T_{j(init)}$ = 25 °C		-	50	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	750	mW
			[3]	-	1.25	W
			[1]	-	2.5	W
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

^[1] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

^[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ui() u)	thermal resistance from		[1] [2]	-	-	200	K/W
	junction to ambient		[1] [3]	-	-	120	K/W
			[1] [4]	-	-	60	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[5]	-	-	12	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [5] Soldering point of cathode tab.

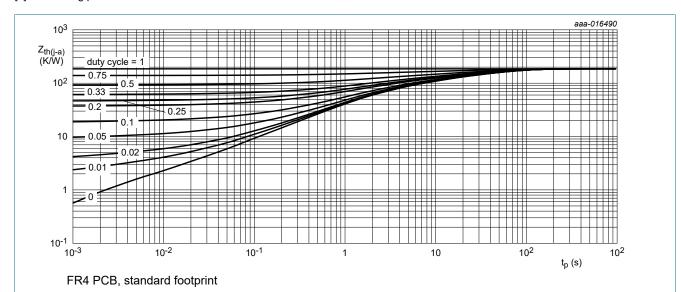


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

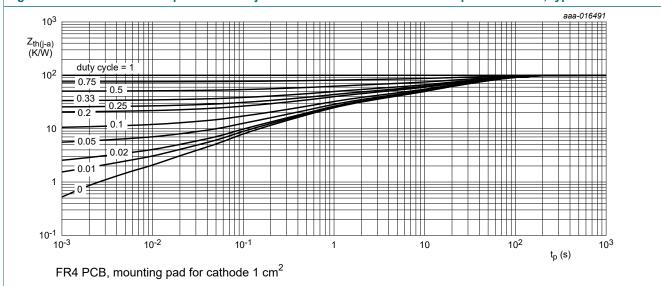
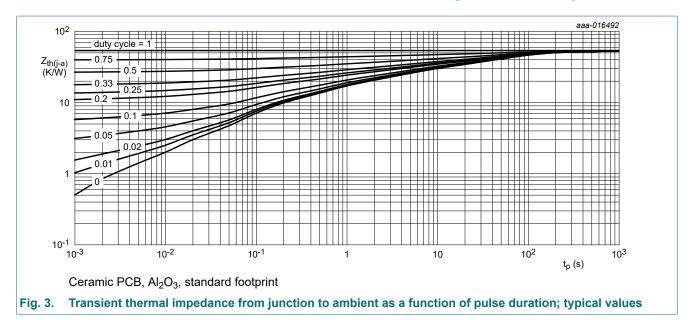


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

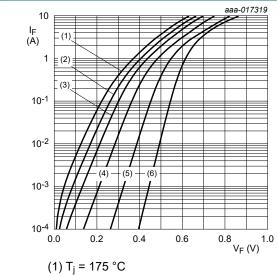


10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{(BR)R}	reverse breakdown voltage	I_R = 1 mA; t_p = 300 μs; δ = 0.02; T_j = 25 °C	60	-	-	V
V _F	forward voltage	I_F = 0.1 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	450	510	mV
		I_F = 0.5 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	510	570	mV
		I_F = 0.7 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	525	590	mV
		I_F = 1 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	545	610	mV
		I_F = 1.6 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	580	650	mV
		I_F = 2 A; t_p ≤ 300 μs; δ ≤ 0.02; T_j = 25 °C	-	600	670	mV
		I_F = 2 A; $t_p \le 300 \ \mu s$; δ ≤ 0.02; T_j = 125 °C	-	510	630	mV
I _R rev	reverse current	V_R = 10 V; $t_p \le 300 \mu s$; δ ≤ 0.02; T_j = 25 °C	-	15	-	nA
		$V_R = 40 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}$	-	50	-	nA
		$V_R = 60 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}$	-	235	700	nA
		$V_R = 60 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 125 ^{\circ}\text{C}$	-	285	1400	μΑ
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	220	-	pF
		V _R = 4 V; f = 1 MHz; T _j = 25 °C	-	135	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C	-	88	-	pF
t _{rr}	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 ^{\circ}\text{C}$	-	9	-	ns

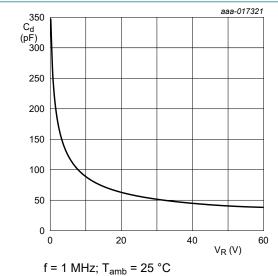
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$	-	565	-	mV



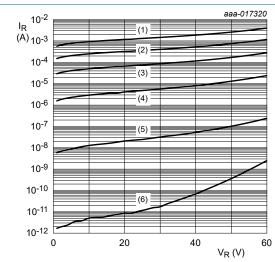
- (2) $T_j = 150 \, ^{\circ}\text{C}$

- (3) $T_j = 125 ^{\circ}C$ (4) $T_j = 85 ^{\circ}C$ (5) $T_j = 25 ^{\circ}C$
- (6) $T_i = -40 \,^{\circ}\text{C}$

Fig. 4. Forward current as a function of forward voltage; typical values



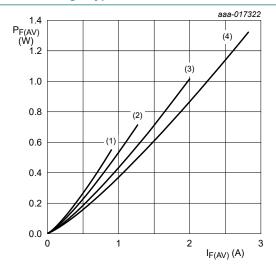
Diode capacitance as a function of reverse Fig. 6. voltage; typical values



- (1) $T_j = 175 \,^{\circ}C$
- (2) $T_j = 150 \,^{\circ}\text{C}$ (3) $T_j = 125 \,^{\circ}\text{C}$

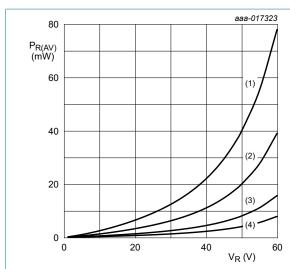
- (4) $T_j = 85 °C$ (5) $T_j = 25 °C$
- (6) $T_j' = -40 \, ^{\circ}C$

Fig. 5. Reverse current as a function of reverse voltage; typical values



- T_i = 175 °C $(1) \delta = 0.1$
- $(2) \delta = 0.2$
- $(3) \delta = 0.5$
- $(4) \delta = 1$

Fig. 7. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 150 \, ^{\circ}C$

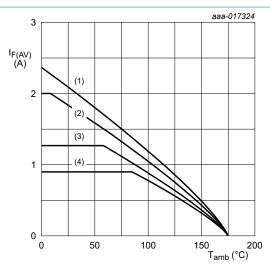
 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

 $(4) \delta = 0.1$; f = 20 kHz

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T_i = 175 °C

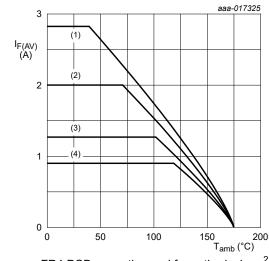
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

 $T_j = 175$ °C

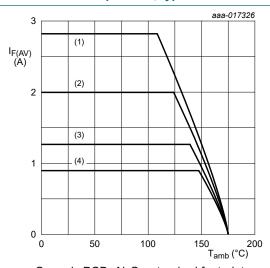
(1) $\delta = 1$; DC

 $(2) \delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al₂O₃, standard footprint

T_j = 175 °C

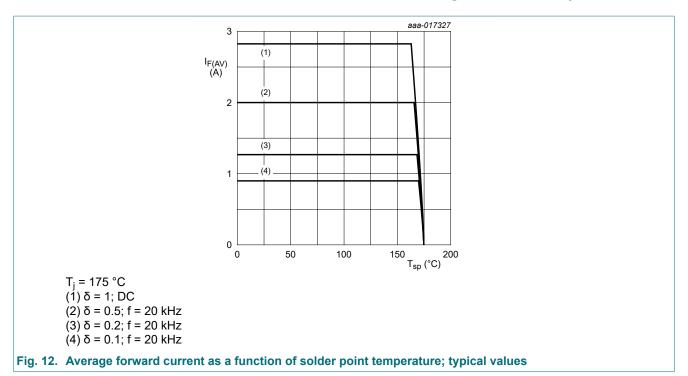
 $(1) \delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

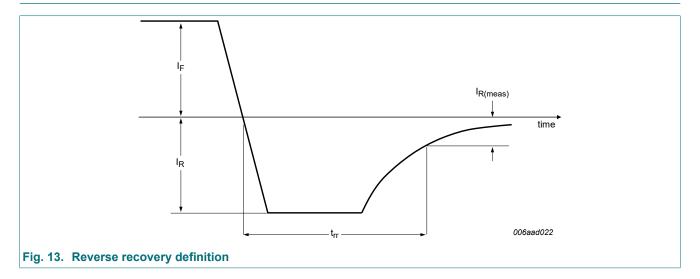
(3) $\delta = 0.2$; f = 20 kHz

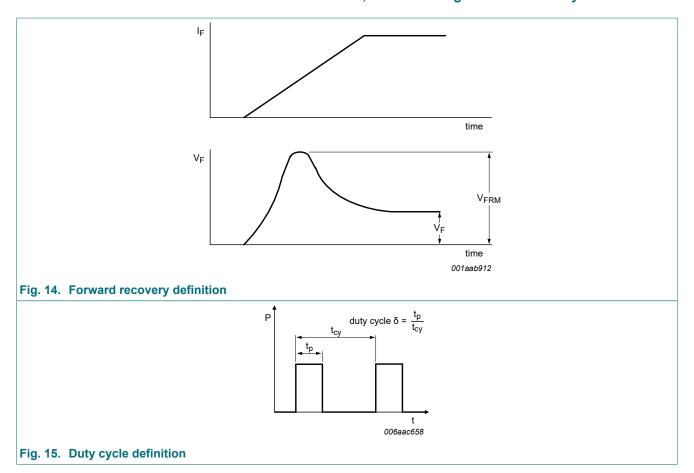
(4) $\delta = 0.1$; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



11. Test information





The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current,

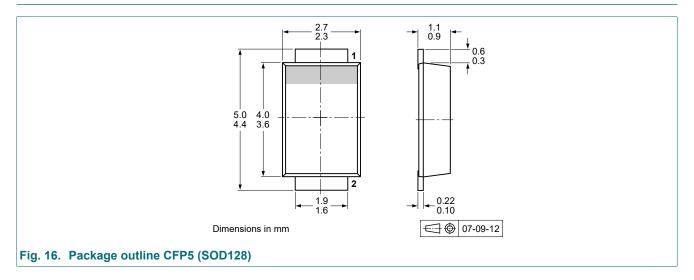
 $I_{RMS} = I_{F(AV)}$ at DC,

 $I_{RMS} = I_{M} \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

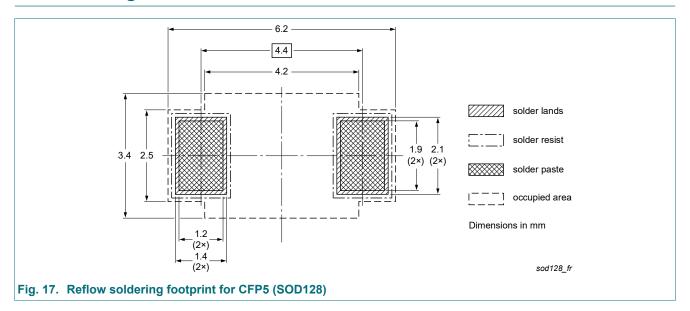
Quality information

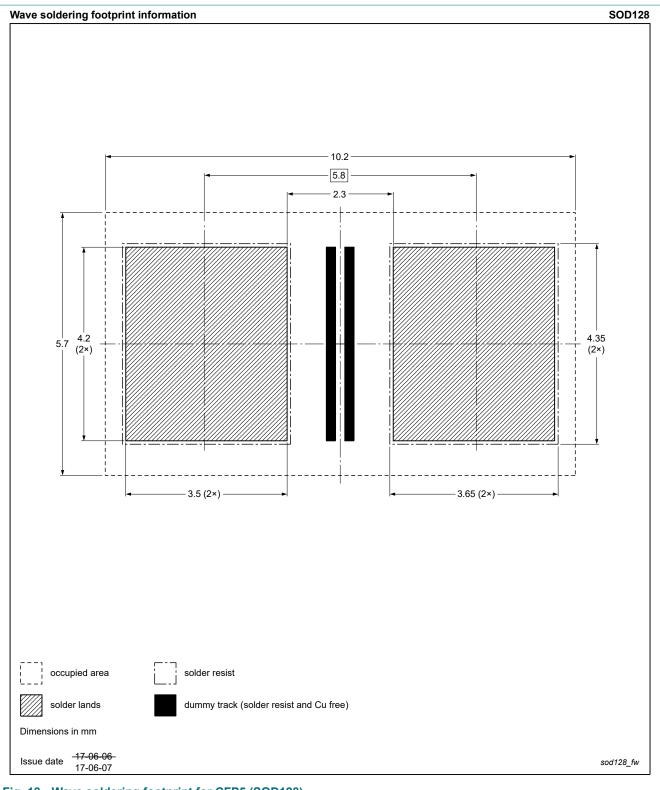
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering





14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PMEG6020AELP-Q v.2	20230220	Product data sheet	-	PMEG6020AELP-Q v.1			
Modifications:		 Limiting values: Measurement conditions for I_{FSM} changed from square wave to half-sine wave. 					
PMEG6020AELP-Q v.1	20210511	Product data sheet	-	-			

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Product data sheet

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